### PATENT ASSIGNMENT

# Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
CHEOL HWAN PARK	12/28/2009
HO JIN CHO	12/28/2009
DONG KYUN LEE	12/28/2009

### **RECEIVING PARTY DATA**

Name:	HYNIX SEMICONDUCTOR INC.	
Street Address:	SAN 136-1, AMI-RI, BUBAL-EUB, ICHEON-SI	
City:	KYOUNGKI-DO	
State/Country: REPUBLIC OF KOREA		

### PROPERTY NUMBERS Total: 1

Property Type	Number	
Application Number:	12649610	

### **CORRESPONDENCE DATA**

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ATTORNEY DOCKET NUMBER: CU-7921 WWP/NK

NAME OF SUBMITTER: Woochoon W. Park

Total Attachments: 2

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PATENT REEL: 023718 FRAME: 0211 .H \$40.00



# UNITED STATES OF AMERICA ASSIGNMENT

In consideration of the payment of ASSIGNEE to ASSIGNOR(S) of the sum of One Dollar (\$1.00), the receipt of which is hereby acknowledged, and for the other good and valuable consideration,

# ASSIGNOR(S):

- a) Cheol Hwan PARK #104-1101, Jinu Apt., Sinha-ri, Bubal-eup, Icheon-si, Gyeonggi-do 467-773, Korea
- b) Ho Jin CHO #502-304, Areummaeul Poonglim Apt., Imae-dong Bundang-gu, Seongnam-si, Gyeonggi-do 463-736, Korea
- c) Dong Kyun LEE #521-1207, Jukong Apt., Jamsil 5-dong, Songpa-gu, Seoul 138-220, Korea

hereby sells, assigns and transfers to

## ASSIGNEE:

### Hynix Semiconductor Inc.

San 136-1, Ami-ri, Bubal-eub, Icheon-si, Kyoungki-do, Korea

### (ASSIGNEE NAME AND ADDRESS)

and the successors, assigns and legal representatives of the ASSIGNEE the entire right, title and interest for the United States and its territorial possessions in and to, any and all improvements which are disclosed in the Application entitled

# SEMICONDUCTOR DEVICE HAVING A HIGH ASPECT CYLINDRICAL CAPACITOR AND METHOD FOR FABRICATING THE SAME

which app	pplication was	
$\triangleleft$	(a) executed on event date herewith	
	(b) filed as Serial No.	on
	and to all Letters Patent to be obtained for sai	

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ASSIGNOR hereby covenants that no assignment, sale agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale;

ASSIGNOR further covenants that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said invention and said Letters Patent and legal equivalents as may be known and accessible to ASSIGNOR and will testify as to the same in any interference or litigation related thereto and will promptly execute and deliver to ASSIGNEE or its legal representatives any and all papers, instruments or affidavits required to apply for, obtain, maintain, issue and enforce said application, said invention and said Letters Patent and said equivalents thereof which may be necessary or desirable to carry out the purposes thereof.

IN WITNESS WHEREOF, I/we have set our hand and seal

Documber 28, 2009	Cheol Hwan Park
Date	INVENTOR Cheol Hwan PARK
December 28, 2009	Ho Jim CHO
Date	INVENTOR Ho Jin CHO
December 28, 2008	Pong Kyun LEE
Date	INVENTOR Dong Kyun LEE

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